RClamp3331Y Ultra Small RailClamp® 1-Line, 3.3V ESD Protection

PROTECTION PRODUCTS - RailClamp®

Description

RailClamp® TVS diodes are ultra low capacitance devices designed to protect sensitive electronics from damage or latch-up due to ESD, EFT, and EOS. They are designed for use on high speed ports in applications such as cell phones, notebook computers, and other portable electronics. These devices offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

RClamp®3331Y features extremely good ESD protection characteristics including a low typical dynamic resistance of 0.27 Ohms, low peak ESD clamping voltage, and high ESD withstand voltage (+/-18kV contact per IEC 61000-4-2). Low typical capacitance (0.35pF at VR=0V) allows the RClamp3331Z to be used in applications operating in excess of 5GHz without appreciable signal attenuation. Each device will protect one high speed data line operating at 3.3 Volts.

RClamp3331Y is in a 2-pin SLP0603P2X3E package measuring 0.6 x 0.3 mm with a nominal height of 0.25mm. Leads are finished with lead-free NiAu. The small package gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of low peak ESD clamping, low dynamic resistance, and low capacitance makes this device suitable for applications such as USB 3.0, MIPI and V-By-One interfaces in portable devices.

Features

- ◆ High ESD withstand Voltage: +/-18kV (Contact/Air) per IEC 61000-4-2
- ◆ Able to withstand over 1000 ESD strikes per IEC 61000-4-2 Level 4
- Ultra-small 0201 package
- Protects one high speed data line
- Working voltage: +/- 3.3V
- ◆ Low capacitance: 0.35pF typical
- ◆ Extremely low dynamic resistance: **0.27 Ohms (Typ)**
- Low ESD clamping voltage
- Solid-state silicon-avalanche technology

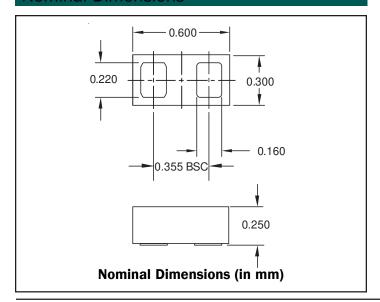
◆ SLP0603P2X3E Package

- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 0.6 x 0.3 x 0.25 mm
- ◆ Lead Finish: NiAu
- Marking: Marking Code
- Packaging: Tape and Reel

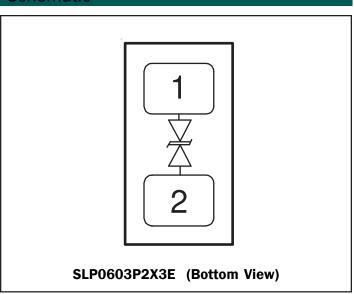
Applications

- ◆ USB 2.0 / USB 3.0
- MIPI / MDDI
- ◆ V-By-One
- eDP
- MHL
- LVDS

Nominal Dimensions



Schematic





Absolute Maximum Rating			
Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P _{pk}	30	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I _{pp}	4	Amps
ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹	V _{ESD}	+/- 18 +/- 18	kV
Operating Temperature	T _J	-40 to +85	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}	Pin 1 to 2 or 2 to 1			3.3	V
Holding Voltage	V _{HOLD}	I _{HOLD} = 50mA Pin 1 to 2 or 2 to 1	1.2	2.8	4.4	V
Reverse Leakage Current	I _R	V _{RWM} = 3.3V, T=25°C Pin 1 to 2 or 2 to 1		<1	50	nA
Clamping Voltage	V _c	I _{pp} = 1A, tp = 8/20µs Pin 1 to 2 or 2 to 1		3.8	5.5	V
Clamping Voltage	V _c	I _{pp} = 4A, tp = 8/20µs Pin 1 to 2 or 2 to 1		5.5	7.5	V
ESD Clamping Voltage ²	V _c	IPP = 4A, tlp = 0.2/100ns		5		V
ESD Clamping Voltage ²	V _c	IPP = 16A, tlp = 0.2/100ns		8.3		V
Trigger Voltage ²	V_{TRIG}	tp = 0.2/100ns		8.8		V
Dynamic Resistance ^{2, 3}	R _D	tp = 0.2/100ns		0.27		Ohms
Junction Capacitance	C _j	$V_R = 0V, f = 1MHz$		0.35	0.45	pF

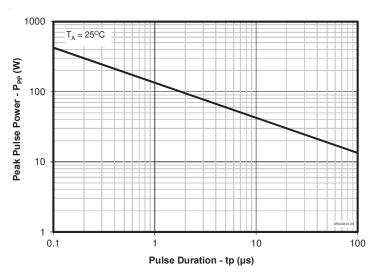
Notes

- 1)ESD gun return path connected to ESD ground reference plane.
- 2)Transmission Line Pulse Test (TLP) Settings: $t_p = 100$ ns, $t_r = 0.2$ ns, l_{TLP} and V_{TLP} averaging window: $t_1 = 70$ ns to $t_2 = 90$ ns.
- $\stackrel{\circ}{\text{3}}$) Dynamic resistance calculated from I_{TLP} = 4A to I_{TLP} = 16A

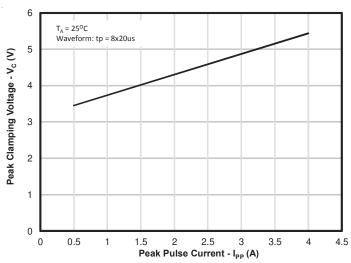


Typical Characteristics

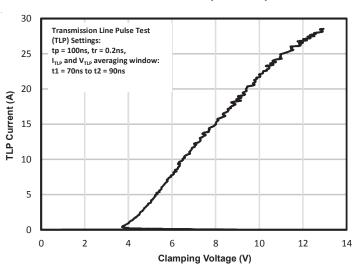
Non-Repetitive Peak Pulse Power vs. Pulse Time



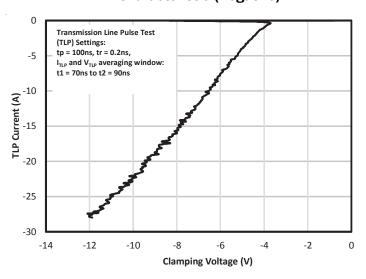
Clamping Voltage vs. Peak Pulse Current (tp=8/20us)



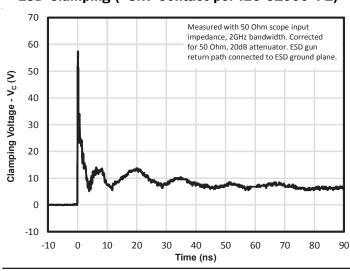
TLP Characteristic (Positive)



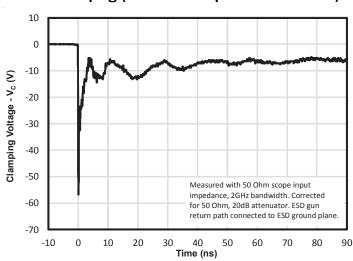
TLP Characteristic (Negative)



ESD Clamping (+8kV Contact per IEC 61000-4-2)



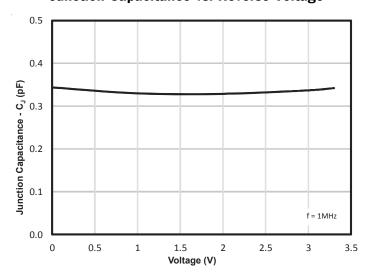
ESD Clamping (-8kV Contact per IEC 61000-4-2)



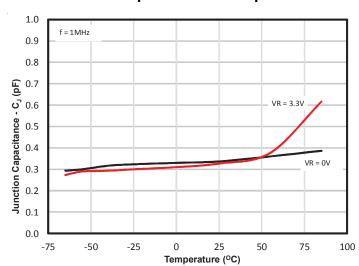


Typical Characteristics

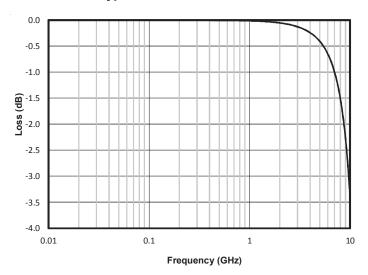
Junction Capacitance vs. Reverse Voltage



Junction Capacitance vs. Temperature



Typical Insertion Loss S21



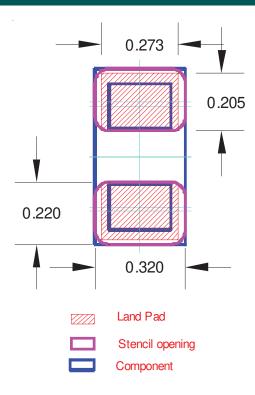


Applications Information

Assembly Guidelines

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joints. The figure at the right details Semtech's recommended aperture based on the assembly guidelines detailed in the table below. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. Exact manufacturing parameters will require some experimentation to get the desired solder application.

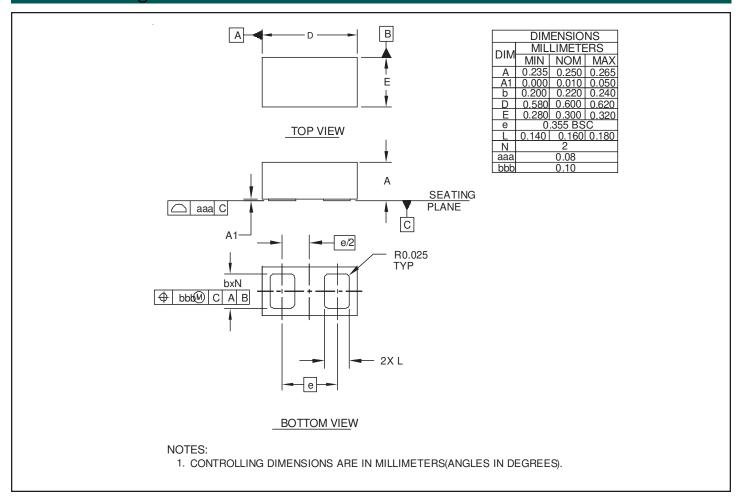
Assembly Parameter	Recommendation	
Solder Stencil Design	Laser cut, Electro-polished	
Aperture shape	Rectangular with rounded corners	
Solder Stencil Thickness	0.100 mm (0.004")	
Solder Paste Type	Type 4 size sphere or smaller	
Solder Reflow Profile	Per JEDEC J-STD-020	
PCB Solder Pad Design	Non-Solder mask defined	
PCB Pad Finish	OSP OR NiAu	



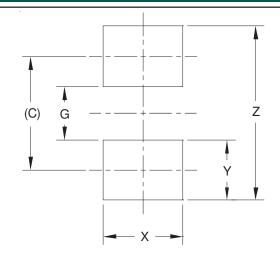
Recommended Mounting Pattern



Outline Drawing - SLP0603P2X3E



Land Pattern - SI P0603P2X3F



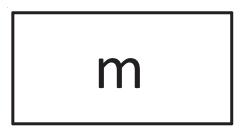
DIMENSIONS		
DIM	MILLIMETERS	
С	(0.385)	
G	0.181	
Χ	0.273	
Υ	0.205	
7	0.590	

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY . CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET .



Marking Code



Ordering Information

Part Number	Qty per	Pocket	Reel
	Reel	Pitch	Size
RClamp3331Y.TFT	15,000	2mm	7 Inch

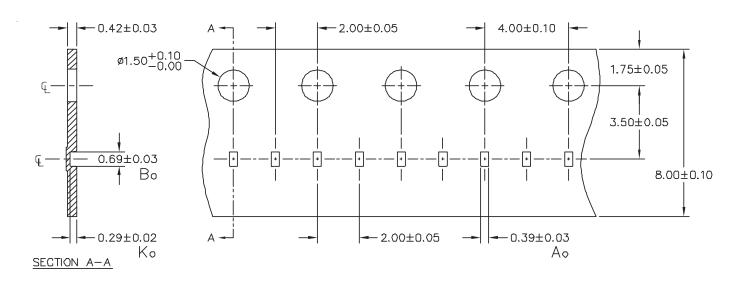
Notes:

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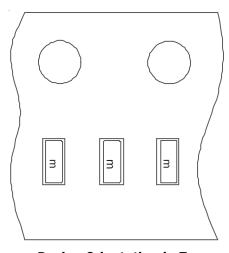
Note:

Device is electrically symmetrical

Carrier Tape Specification



NOTES: ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.



Device Orientation in Tape



Contact Information

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